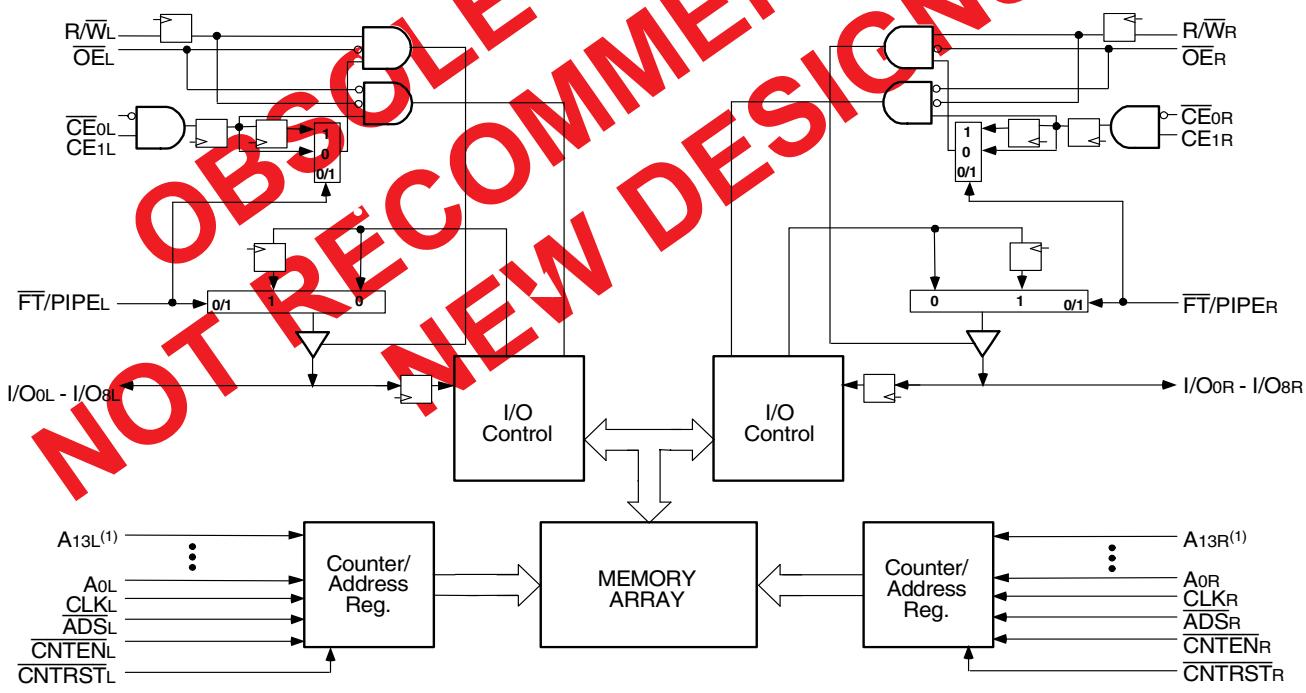


Features

- True Dual-Ported memory cells which allow simultaneous access of the same memory location
- High-speed clock to data access
 - Commercial: 7.5/9/12ns (max.)
 - Industrial: 9ns (max.)
- Low-power operation
 - IDT70T9169/59L
 - Active: 225mW (typ.)
 - Standby: 1.5mW (typ.)
- Flow-Through or Pipelined output mode on either Port via the FT/PIPE pins
- Counter enable and reset features
- Dual chip enables allow for depth expansion without additional logic
- Full synchronous operation on both ports
 - 4.0ns setup to clock and 0.5ns hold on all control, data, and address inputs
 - Data input, address, and control registers
 - Fast 7.5ns clock to data out in the Pipelined output mode
 - Self-timed write allows fast cycle time
 - 12ns cycle time, 83MHz operation in Pipelined output mode
- LVTTL-compatible, single 2.5V ($\pm 100\text{mV}$) power supply
- Industrial temperature range (-40°C to +85°C) is available for 66MHz
- Available in a 100-pin Thin Quad Flatpack (TQFP) and 100-pin fine pitch Ball Grid Array (fpBGA) packages

Functional Block Diagram



NOTE:

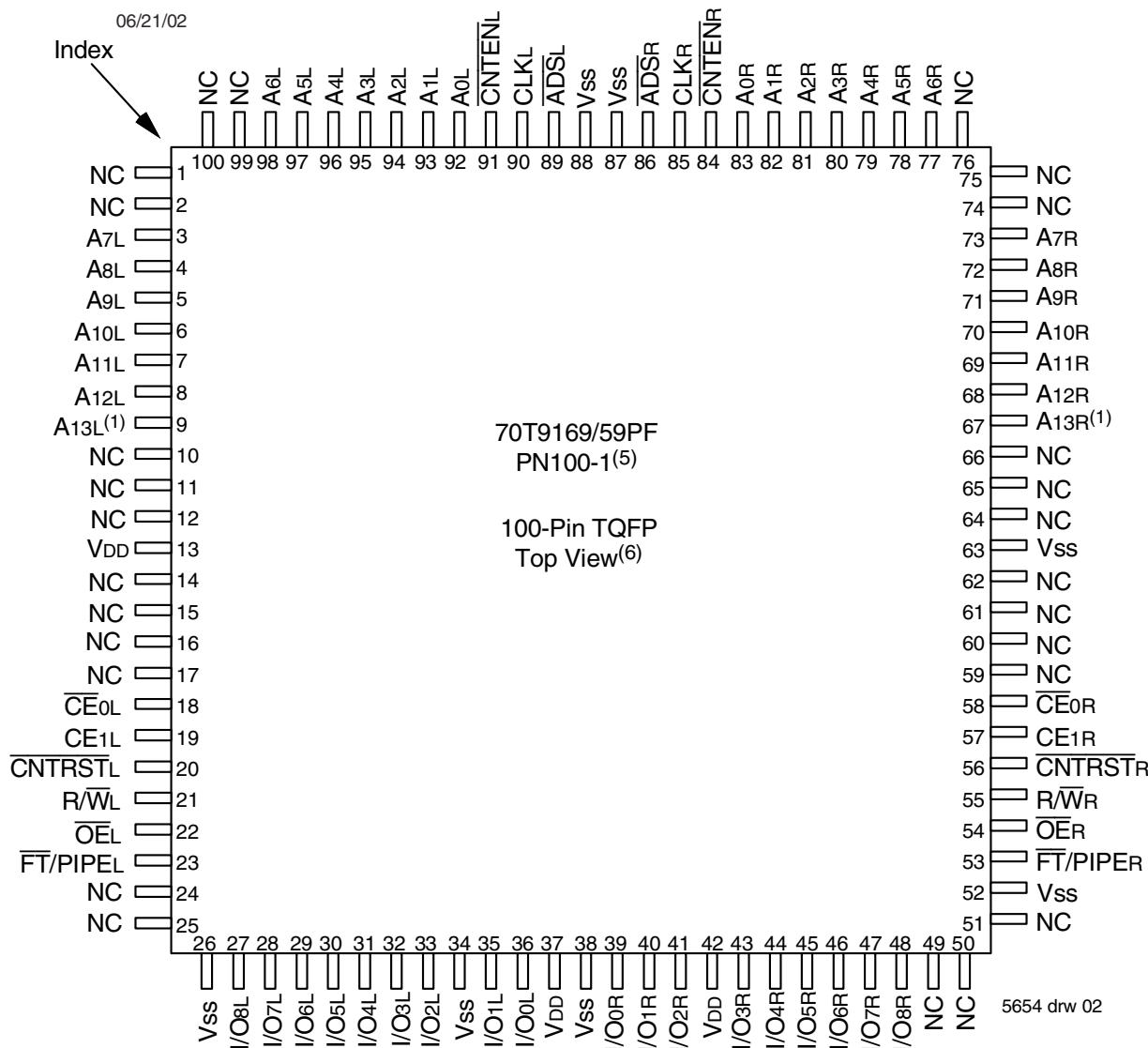
1. A13 is a NC for IDT70T9159.

Description

The IDT70T9169/59 is a high-speed 16/8Kx9 bits synchronous Dual-Port RAM. The memory array utilizes Dual-Port memory cells to allow simultaneous access of any address from both ports. Registers on control, data, and address inputs provide minimal setup and hold times. The timing latitude provided by this approach allows systems to be designed with very short cycle times.

With an input data register, the IDT70T9169/59 has been optimized for applications having unidirectional or bidirectional data flow in bursts. An automatic power down feature, controlled by \overline{CE}_0 and CE_1 , permits the on-chip circuitry of each port to enter a very low standby power mode. Fabricated using IDT's CMOS high-performance technology, these devices typically operate on only 225mW of power.

Pin Configurations^(1,2,3,4)



NOTES:

1. A₁₃ is a NC for IDT70T9159.
2. All VDD pins must be connected to power supply.
3. All VSS pins must be connected to ground supply.
4. Package body is approximately 14mm x 14mm x 1.4mm.
5. This package code is used to reference the package diagram.
6. This text does not indicate orientation of the actual part-marking.

Pin Configurations (con't.)^(1,2,3,4)

70T9169/59BF
BF100⁽⁵⁾

100-Pin fpBGA
Top View⁽⁶⁾
06/21/02

A1 A6R	A2 A9R	A3 A12R	A4 NC	A5 Vss	A6 Vss	A7 NC	A8 R/W _R	A9 Vss	A10 NC
B1 A4R	B2 A5R	B3 A8R	B4 A10R	B5 NC	B6 NC	B7 NC	B8 OE _R	B9 NC	B10 I/O _{6R}
C1 A3R	C2 NC	C3 NC	C4 A7R	C5 NC	C6 CE _{0R}	C7 CE _{1R}	C8 PL/FT _R	C9 I/O _{7R}	C10 I/O _{3R}
D1 A0R	D2 CLK _R	D3 A1R	D4 A2R	D5 A11R	D6 A13R ⁽¹⁾	D7 CNTRST _R	D8 I/O _{8R}	D9 I/O _{5R}	D10 I/O _{1R}
E1 Vss	E2 ADS _R	E3 CNTEN _R	E4 A1L	E5 ADS _L	E6 Vss	E7 I/O _{4R}	E8 I/O _{2R}	E9 I/O _{0R}	E10 VDD
F1 Vss	F2 CLK _L	F3 A0L	F4 A3L	F5 VDD	F6 Vss	F7 VDD	F8 I/O _{2L}	F9 I/O _{1L}	F10 I/O _{0L}
G1 CNTEN _L	G2 NC	G3 A5L	G4 A12L	G5 NC	G6 R/W _L	G7 NC	G8 I/O _{4L}	G9 Vss	G10 I/O _{3L}
H1 A2L	H2 A4L	H3 A9L	H4 A13L ⁽¹⁾	H5 NC	H6 CE _{1L}	H7 NC	H8 I/O _{7L}	H9 I/O _{6L}	H10 I/O _{5L}
J1 NC	J2 A7L	J3 A10L	J4 NC	J5 NC	J6 NC	J7 OE _L	J8 Vss	J9 Vss	J10 I/O _{8L}
K1 A6L	K2 A8L	K3 A11L	K4 NC	K5 VDD	K6 VDD	K7 CE _{0L}	K8 CNTRST _L	K9 PL/FT _L	K10 NC

5654 drw 03

NOTES:

1. A13 is a NC for IDT70T9159.
2. All VDD pins must be connected to power supply.
3. All Vss pins must be connected to ground supply.
4. Package body is approximately 10mm x 10mm x 1.4mm with 0.8mm ball pitch.
5. This package code is used to reference the package diagram.
6. This text does not indicate orientation of the actual part-marking.

Pin Names

Left Port	Right Port	Names
\overline{CE}_0L , CE_{1L}	\overline{CE}_0R , CE_{1R}	Chip Enables
R/W_L	R/W_R	Read/Write Enable
\overline{OE}_L	\overline{OE}_R	Output Enable
$A_0L - A_{13L}^{(1)}$	$A_0R - A_{13R}^{(1)}$	Address
$I/O_0L - I/O_8L$	$I/O_0R - I/O_8R$	Data Input/Output
CLK_L	CLK_R	Clock
ADS_L	ADS_R	Address Strobe
\overline{CNTEN}_L	\overline{CNTEN}_R	Counter Enable
\overline{CNTRST}_L	\overline{CNTRST}_R	Counter Reset
$\overline{FT}/PIPE_L$	$\overline{FT}/PIPE_R$	Flow-Through/Pipeline
V_{DD}		Power (2.5V)
V_{SS}		Ground (0V)

5654 tbl 01

NOTE:

1. A_{13} is a NC for IDT70T9159.

Truth Table I—Read/Write and Enable Control^(1,2,3)**NOTES:**

1. "H" = V_{IH} , "L" = V_{IL} , "X" = Don't Care.
2. \overline{ADS} , \overline{CNTEN} , $\overline{CNTRST} = X$.
3. \overline{OE} is an asynchronous input signal.

Truth Table II—Address Counter Control^(1,2)

External Address	Previous Internal Address	Internal Address Used	CLK	<u>ADS</u>	<u>CNTEN</u>	<u>CNTRST</u>	I/O ⁽³⁾	MODE	
								D/Io (n)	External Address Used
An	X	An	↑	L ⁽⁴⁾	X	H	D/Io (n)		External Address Used
X	An	An + 1	↑	H	L ⁽⁵⁾	H	D/Io(n+1)		Counter Enabled—Internal Address generation
X	An + 1	An + 1	↑	H	H	H	D/Io(n+1)		External Address Blocked—Counter disabled (An + 1 reused)
X	X	A0	↑	X	X	L ⁽⁴⁾	D/Io(0)		Counter Reset to Address 0

5654 tbl 03

NOTES:

1. "H" = V_{IH}, "L" = V_{IL}, "X" = Don't Care.
2. CE₀ and OE = V_{IL}; CE₁ and R/W = V_{IH}.
3. Outputs configured in Flow-Through Output mode: if outputs are in Pipelined mode the data out will be delayed by one cycle.
4. ADS and CNTRST are independent of all other signals including CE₀ and CE₁.
5. The address counter advances if CNTEN = V_{IL} on the rising edge of CLK, regardless of all other signals including CE₀ and CE₁.

Recommended Operating Temperature and Supply Voltage

Grade	Ambient Temperature ⁽¹⁾	GND	V _{DD}
Commercial	0°C to +70°C	0V	2.5V ± 100mV
Industrial	-40°C to +85°C	0V	2.5V ± 100mV

5654 tbl 04

NOTES:

1. This is the parameter T_A. This is the "instant on" case temperature.

Recommended DC Operating Conditions

Symbol	Parameter	Min.	Typ.	Max.	Unit
V _{DD}	Supply Voltage	2.4	2.5	2.6	V
V _{SS}	Ground	0	0	0	V
V _{IH}	Input High Voltage	1.7	—	V _{DD} +0.3V ⁽²⁾	V
V _{IL}	Input Low Voltage	-0.3 ⁽¹⁾	—	0.7	V

5654 tbl 05

NOTES:

1. V_{IL} ≥ -1.5V for pulse width less than 10 ns.
2. V_{TERM} must not exceed V_{DD} + 0.3V.

Absolute Maximum Ratings⁽¹⁾

Symbol	Rating	Commercial & Industrial	Unit
V _{TERM} ⁽²⁾	Terminal Voltage with Respect to GND	-0.5 to +3.6	V
T _{BIAZ} ⁽³⁾	Temperature Under Bias	-55 to +125	°C
T _{STG}	Storage Temperature	-65 to +150	°C
I _{OUT}	DC Output Current	50	mA

5654 tbl 06

NOTES:

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
2. V_{TERM} must not exceed V_{DD} + 0.3.
3. Ambient Temperature Under Bias. AC Conditions. Chip Deselected.

Capacitance⁽¹⁾

(TA = +25°C, f = 1.0MHz)

Symbol	Parameter	Conditions ⁽²⁾	Max.	Unit
C _{IN}	Input Capacitance	V _{IN} = 0V	9	pF
C _{OUT} ⁽²⁾	Output Capacitance	V _{OUT} = 0V	10	pF

5654 tbl 07

NOTES:

1. These parameters are determined by device characterization, but are not production tested.
2. C_{OUT} also references C_{IO}.

DC Electrical Characteristics Over the Operating Temperature Supply Voltage Range ($V_{DD} = 2.5V \pm 100mV$)

Symbol	Parameter	Test Conditions	70T9169/59L		Unit
			Min.	Max.	
$ I_{U }$	Input Leakage Current ⁽¹⁾	$V_{DD} = 2.6V$, $V_{IN} = 0V$ to V_{DD}	—	5	μA
$ I_{O }$	Output Leakage Current	$\bar{CE} = V_{IH}$ or $CE1 = V_{IL}$, $V_{OUT} = 0V$ to V_{DD}	—	5	μA
V_{OL}	Output Low Voltage	$I_{OL} = +2mA$	—	0.4	V
V_{OH}	Output High Voltage	$I_{OH} = -2mA$	2.0	—	V

5654 tbl 08

NOTE:

- At $V_{CC} \leq 2.0V$ input leakages are undefined.

DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range⁽³⁾ ($V_{DD} = 2.5V \pm 100mV$)

Symbol	Parameter	Test Condition	Version	70T9169/59L7 Com'l Only		70T9169/59L9 Com'l & Ind		70T9169/59L12 Com'l Only		Unit
				Typ. ⁽⁴⁾	Max.	Typ. ⁽⁴⁾	Max.	Typ. ⁽⁴⁾	Max.	
IDD	Dynamic Operating Current (Both Ports Active)	\bar{CE}_L and $\bar{CE}_R = V_{IL}$, Outputs Disabled, $f = f_{MAX}^{(1)}$	COM'L L	80	200	75	175	70	150	mA
			IND L	—	—	75	220	—	—	
ISB1	Standby Current (Both Ports - TTL Level Inputs)	$\bar{CE}_L = \bar{CE}_R = V_{IH}$ $f = f_{MAX}^{(1)}$	COM'L L	20	60	20	50	20	40	mA
			IND L	—	—	20	70	—	—	
ISB2	Standby Current (One Port - TTL Level Inputs)	$\bar{CE}_A'' = V_{IL}$ and $\bar{CE}_B'' = V_{IH}^{(5)}$ Active Port Outputs Disabled, $f = f_{MAX}^{(1)}$	COM'L L	50	115	47	100	45	85	mA
			IND L	—	—	47	190	—	—	
ISB3	Full Standby Current (Both Ports - CMOS Level Inputs)	Both Ports \bar{CE}_L and $\bar{CE}_R \geq V_{DD} - 0.2V$, $V_{IN} \geq V_{DD} - 0.2V$ or $V_{IN} \leq 0.2V$, $f = 0^{(2)}$	COM'L L	0.1	3.0	0.1	3.0	0.1	3.0	mA
			IND L	—	—	0.1	3.0	—	—	
ISB4	Full Standby Current (One Port - CMOS Level Inputs)	$\bar{CE}_A'' \leq 0.2V$ and $\bar{CE}_B'' \geq V_{DD} - 0.2V^{(5)}$ $V_{IN} \geq V_{DD} - 0.2V$ or $V_{IN} \leq 0.2V$, Active Port, Outputs Disabled, $f = f_{MAX}^{(1)}$	COM'L L	50	115	47	100	45	85	mA
			IND L	—	—	47	190	—	—	

5654 tbl 09

NOTES:

- At $f = f_{MAX}$, address and control lines (except Output Enable) are cycling at the maximum frequency clock cycle of $1/t_{cyc}$, using "AC TEST CONDITIONS" at input levels of GND to 2.5V.
- $f = 0$ means no address, clock, or control lines change. Applies only to input at CMOS level standby.
- Port "A" may be either left or right port. Port "B" is the opposite from port "A".
- $V_{DD} = 2.5V$, $T_A = 25^\circ C$ for Typ, and are not production tested. $Id_{dc}(f=0) = 75mA$ (Typ).
- $\bar{CE}_{Ex} = V_{IL}$ means $CE_{0x} = V_{IL}$ and $CE_{1x} = V_{IH}$
 $\bar{CE}_{Ex} = V_{IH}$ means $CE_{0x} = V_{IH}$ or $CE_{1x} = V_{IL}$
 $\bar{CE}_{Ex} \leq 0.2V$ means $CE_{0x} \leq 0.2V$ and $CE_{1x} \geq V_{DD} - 0.2V$
 $\bar{CE}_{Ex} \geq V_{DD} - 0.2V$ means $CE_{0x} \geq V_{DD} - 0.2V$ or $CE_{1x} \leq 0.2V$
"X" represents "L" for left port or "R" for right port.

AC Test Conditions

Input Pulse Levels	GND to 2.5V
Input Rise/Fall Times	2ns Max.
Input Timing Reference Levels	1.25V
Output Reference Levels	1.25V
Output Load	Figures 1 and 2

5654 tbl 10

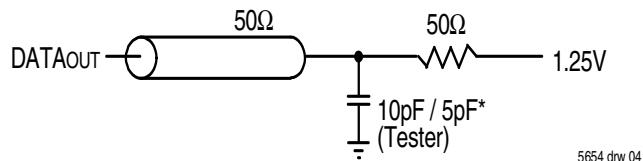


Figure 1. AC Output Test load.

*(For tcklz, tckhz, tolz, and tohz).

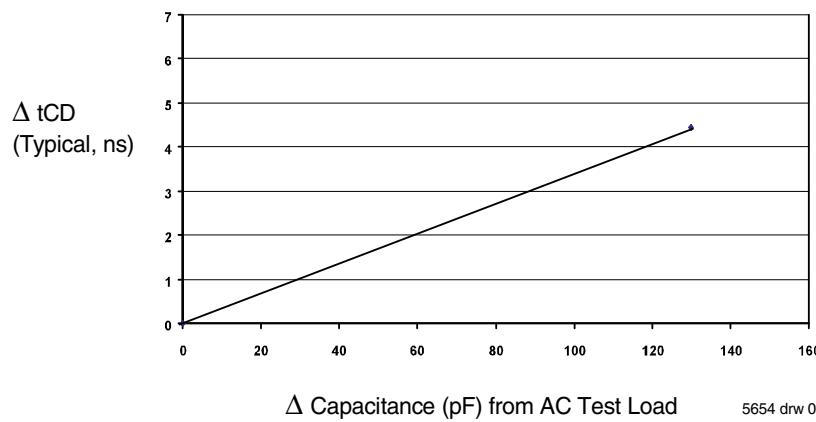


Figure 2. Typical Output Derating (Lumped Capacitive Load).

AC Electrical Characteristics Over the Operating Temperature Range (Read and Write Cycle Timing)⁽³⁾ ($V_{DD} = 2.5V \pm 100mV$, $T_A = 0^\circ C$ to $+70^\circ C$)

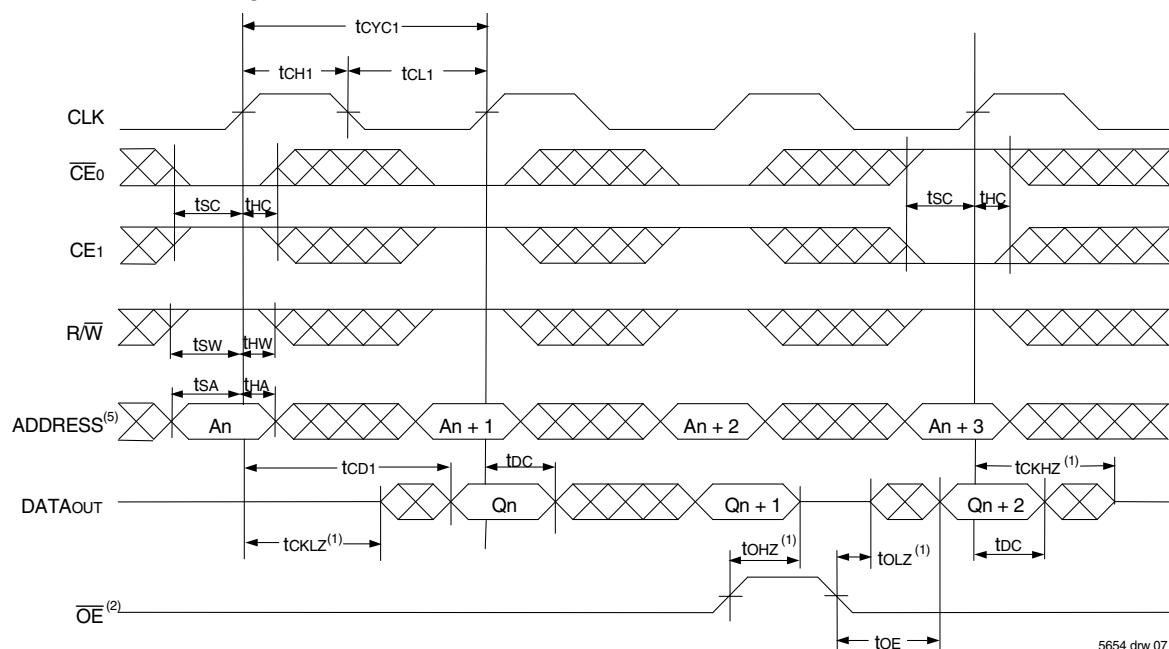
		70T9169/59L7 Com'l Only	70T9169/59L9 Com'l & Ind	70T9169/59L12 Com'l Only				
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Unit
tCYC1	Clock Cycle Time (Flow-Through) ⁽²⁾	22	—	25	—	30	—	ns
tCYC2	Clock Cycle Time (Pipelined) ⁽²⁾	12	—	15	—	20	—	ns
tCH1	Clock High Time (Flow-Through) ⁽²⁾	7.5	—	12	—	12	—	ns
tCL1	Clock Low Time (Flow-Through) ⁽²⁾	7.5	—	12	—	12	—	ns
tCH2	Clock High Time (Pipelined) ⁽²⁾	5	—	6	—	8	—	ns
tCL2	Clock Low Time (Pipelined) ⁽²⁾	5	—	6	—	8	—	ns
tR	Clock Rise Time	—	3	—	3	—	3	ns
tF	Clock Fall Time	—	3	—	3	—	3	ns
tSA	Address Setup Time	4	—	4	—	4	—	ns
tHA	Address Hold Time	0	—	1	—	1	—	ns
tSC	Chip Enable Setup Time	4	—	4	—	4	—	ns
tHC	Chip Enable Hold Time	0	—	1	—	1	—	ns
tSB	Byte Enable Setup Time	4	—	4	—	4	—	ns
tHB	Byte Enable Hold Time	0	—	1	—	1	—	ns
tSW	R/W Setup Time	4	—	4	—	4	—	ns
tHW	R/W Hold Time	0	—	1	—	1	—	ns
tSD	Input Data Setup Time	4	—	4	—	4	—	ns
tHD	Input Data Hold Time	0	—	1	—	1	—	ns
tSAD	ADS Setup Time	4	—	4	—	4	—	ns
tHAD	ADS Hold Time	0	—	1	—	1	—	ns
tSCN	CNTEN Setup Time	4	—	4	—	4	—	ns
tHCN	CNTEN Hold Time	0	—	1	—	1	—	ns
tSRST	CNTRST Setup Time	4	—	4	—	4	—	ns
tHRST	CNTRST Hold Time	0	—	1	—	1	—	ns
tOE	Output Enable to Data Valid	—	7.5	—	9	—	12	ns
tOLZ	Output Enable to Output Low-Z ⁽¹⁾	2	—	2	—	2	—	ns
tOHZ	Output Enable to Output High-Z ⁽¹⁾	1	7	1	7	1	7	ns
tCD1	Clock to Data Valid (Flow-Through) ⁽²⁾	—	18	—	20	—	25	ns
tCD2	Clock to Data Valid (Pipelined) ⁽²⁾	—	7.5	—	9	—	12	ns
tDC	Data Output Hold After Clock High	2	—	2	—	2	—	ns
tCKHZ	Clock High to Output High-Z ⁽¹⁾	2	9	2	9	2	9	ns
tCKLZ	Clock High to Output Low-Z ⁽¹⁾	2	—	2	—	2	—	ns
Port-to-Port Delay								
tOWDD	Write Port Clock High to Read Data Delay	—	28	—	35	—	40	ns
tocs	Clock-to-Clock Setup Time	—	10	—	15	—	15	ns

NOTES:

- Transition is measured 0mV from Low or High-impedance voltage with the Output Test Load (Figure 2). This parameter is guaranteed by device characterization, but is not production tested.
- The Pipelined output parameters (tCYC2, tCD2) to either the Left or Right ports when $\overline{FT}/PIPE = V_{IH}$. Flow-Through parameters (tCYC1, tCD1) apply when $\overline{FT}/PIPE = V_{IL}$ for that port.
- All input signals are synchronous with respect to the clock except for the asynchronous Output Enable (\overline{OE}), $\overline{FT}/PIPE_R$ and $\overline{FT}/PIPE_L$.

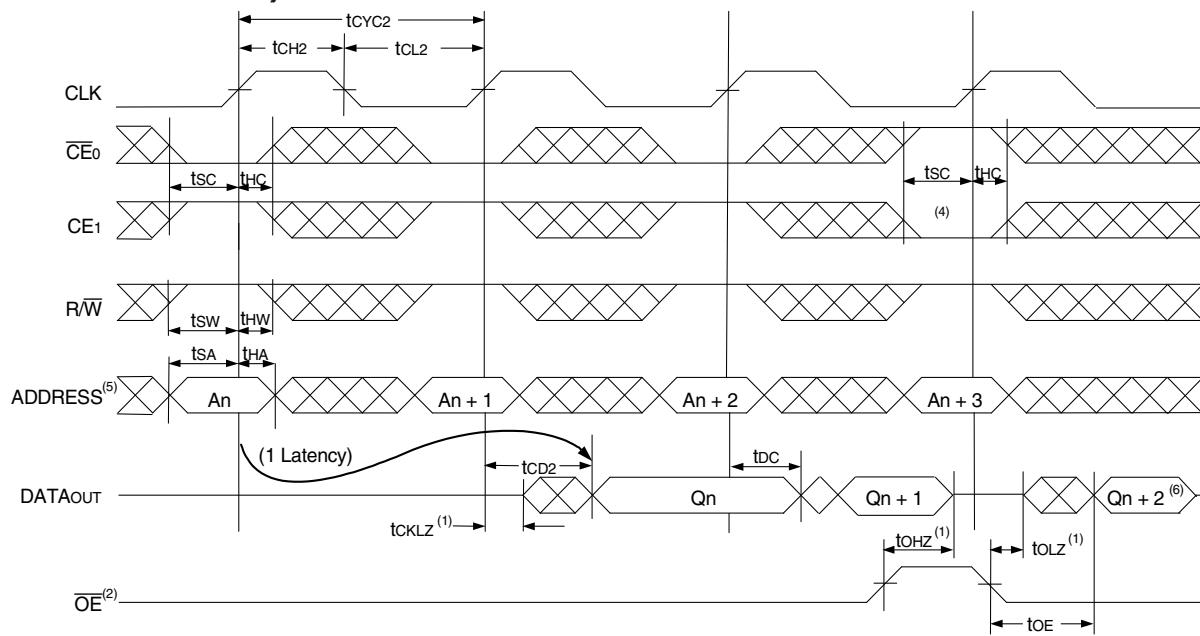
5654tbl11

Timing Waveform of Read Cycle for Flow-Through Output ($\overline{FT/PIPE}^X = V_{IL}$)^(3,6)



5654 drw 07

Timing Waveform of Read Cycle for Pipelined Operation ($\overline{FT/PIPE}^X = V_{IH}$)^(3,6)

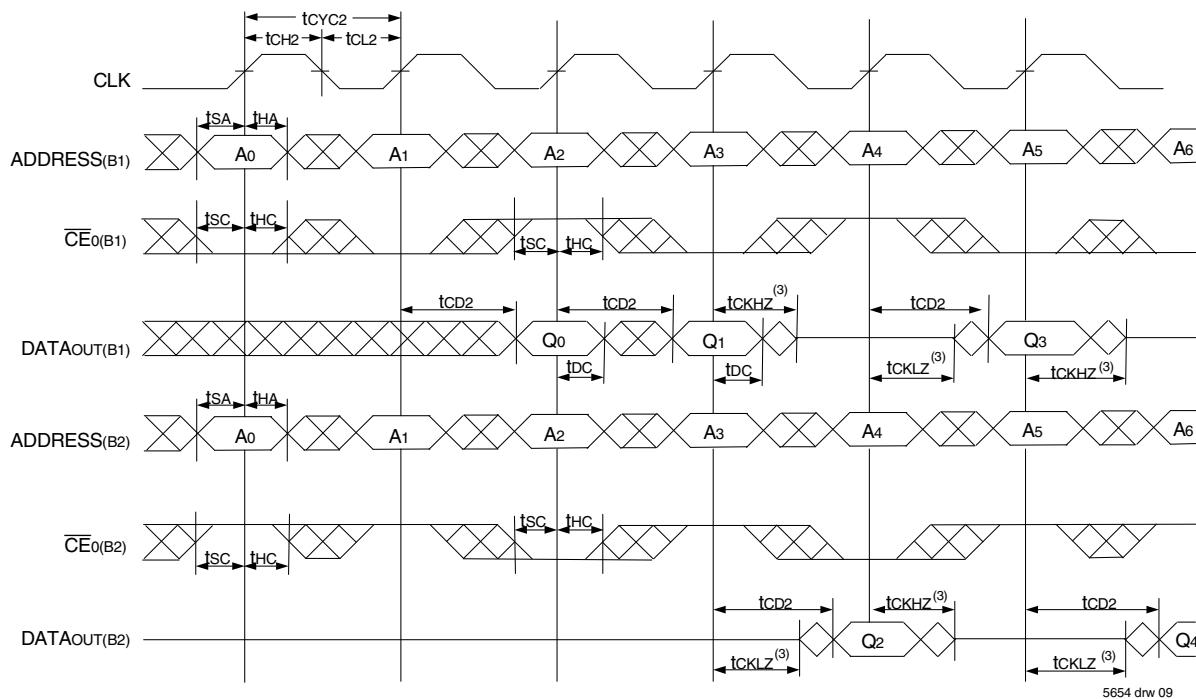


5654 drw 08

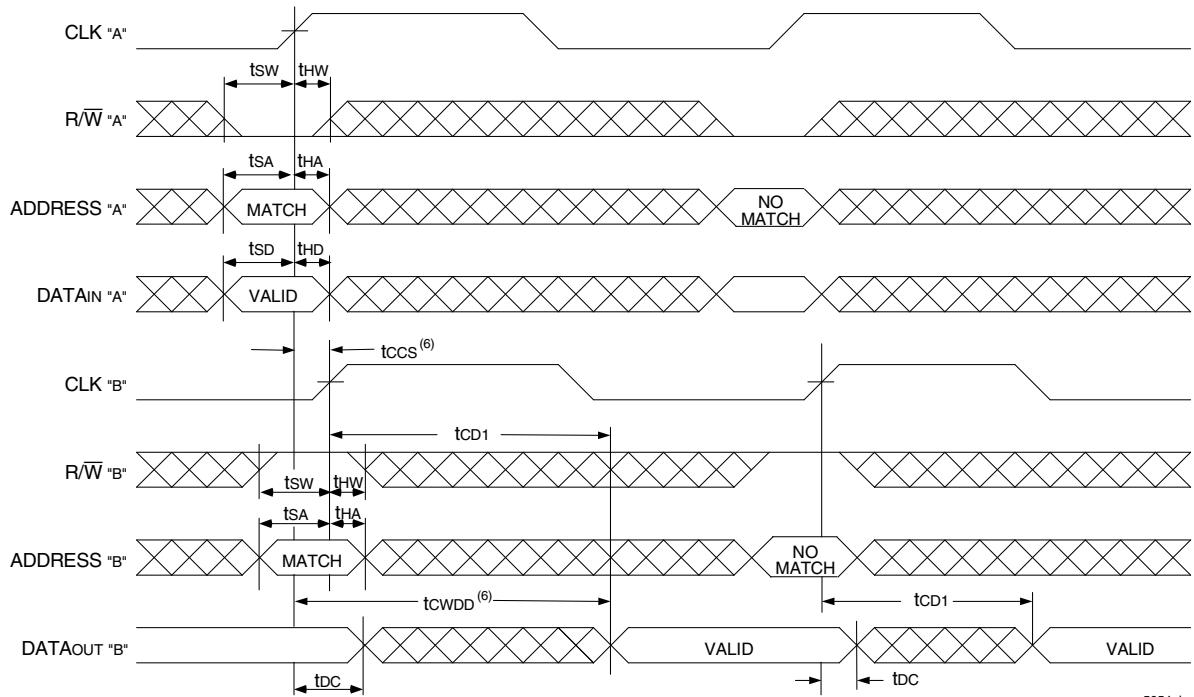
NOTES:

1. Transition is measured 0mV from Low or High-impedance voltage with the Output Test Load (Figure 2).
2. \overline{OE} is asynchronously controlled; all other inputs are synchronous to the rising clock edge.
3. $\overline{ADS} = V_{IL}$, \overline{CNTEN} and $\overline{CNTRST} = V_{IH}$.
4. The output is disabled (High-Impedance state) by $\overline{CE}_0 = V_{IH}$ or $CE_1 = V_{IL}$ following the next rising edge of the clock. Refer to Truth Table 1.
5. Addresses do not have to be accessed sequentially since $\overline{ADS} = V_{IL}$ constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
6. "X" here denotes Left or Right port. The diagram is with respect to that port.

Timing Waveform of a Bank Select Pipelined Read^(1,2)



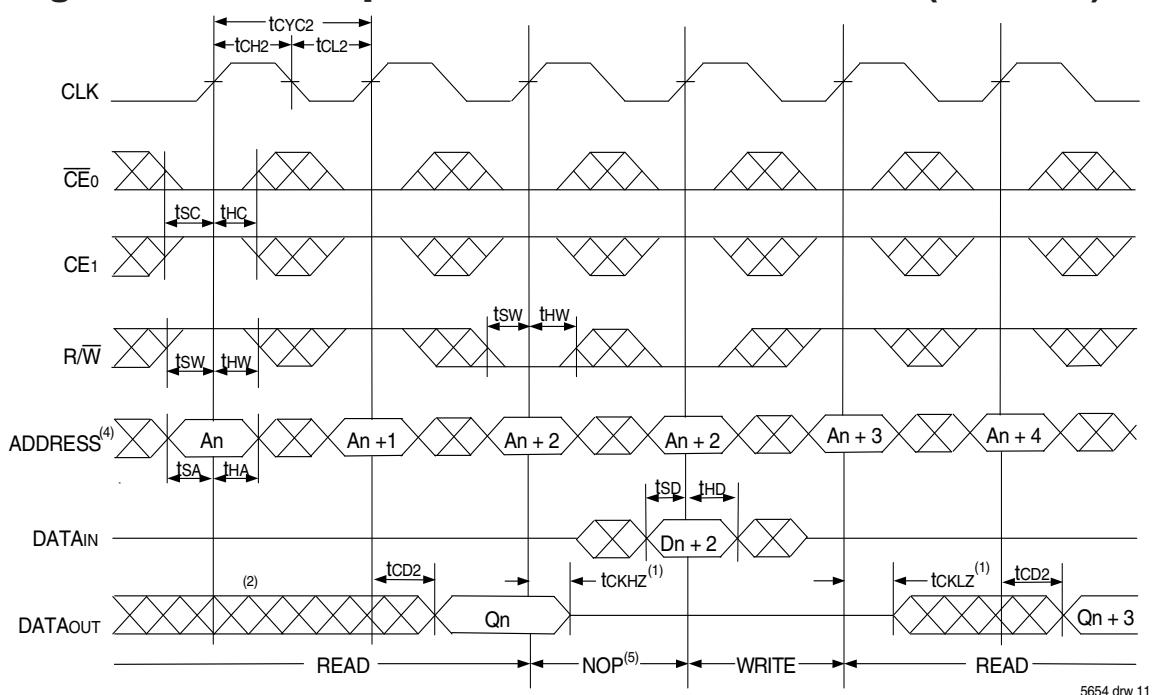
Timing Waveform of Write with Port-to-Port Flow-Through Read^(4,5,7)



NOTES:

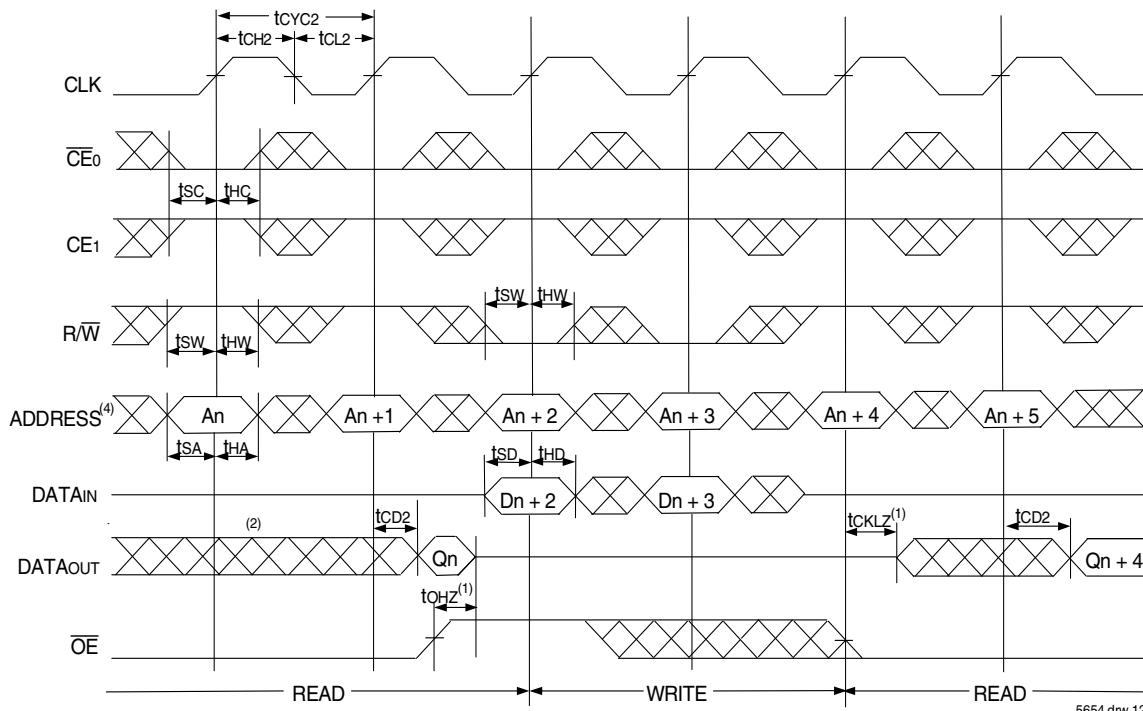
1. B1 Represents Bank #1; B2 Represents Bank #2. Each Bank consists of one IDT70T9169/59 for this waveform, and are setup for depth expansion in this example. ADDRESS(B1) = ADDRESS(B2) in this situation.
2. \overline{OE} and \overline{ADS} = V_{IL} ; $CE_1(B1)$, $CE_1(B2)$, R/W , $CNTEN$, and \overline{CNTRST} = V_{IH} .
3. Transition is measured 0mV from Low or High-impedance voltage with the Output Test Load (Figure 2).
4. \overline{CE}_0 and \overline{ADS} = V_{IL} ; CE_1 , \overline{CNTEN} , and \overline{CNTRST} = V_{IH} .
5. \overline{OE} = V_{IL} for the Right Port, which is being read from. \overline{OE} = V_{IH} for the Left Port, which is being written to.
6. If $tccs \leq$ maximum specified, then data from right port READ is not valid until the maximum specified for tcwdd.
- If $tccs >$ maximum specified, then data from right port READ is not valid until $tccs + tcd1$. tcwdd does not apply in this case.
7. All timing is the same for both Left and Right ports. Port "A" may be either Left or Right port. Port "B" is the opposite from Port "A".

Timing Waveform of Pipelined Read-to-Write-to-Read ($\overline{OE} = V_{IL}$)⁽³⁾



5654 drw 11

Timing Waveform of Pipelined Read-to-Write-to-Read (\overline{OE} Controlled)⁽³⁾

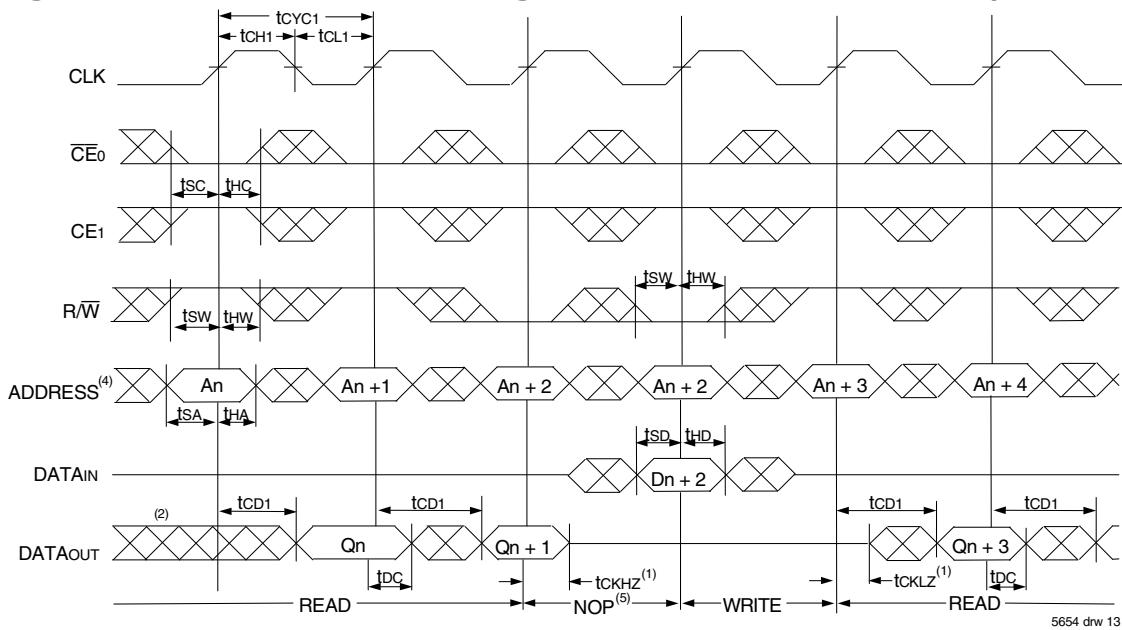


5654 drw 12

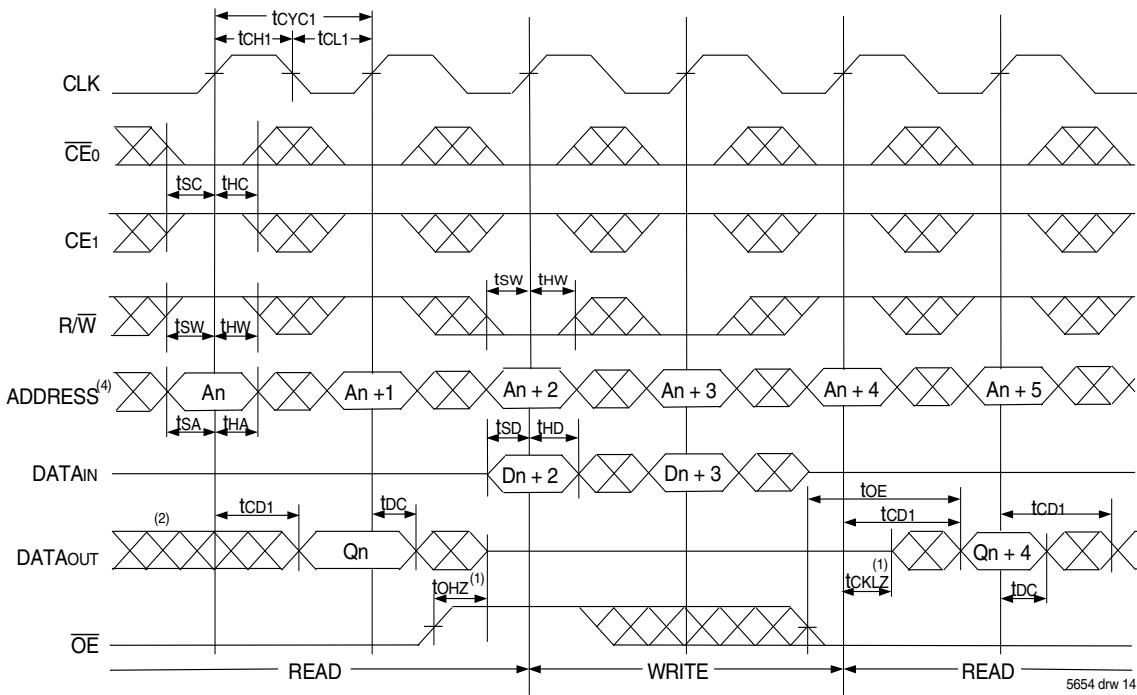
NOTES:

1. Transition is measured 0mV from Low or High-impedance voltage with the Output Test Load (Figure 2).
2. Output state (High, Low, or High-impedance) is determined by the previous cycle control signals.
3. \overline{CE}_0 and $\overline{ADS} = V_{IL}$; CE_1 , $CNTEN$, and $CNTRST = V_{IH}$. "NOP" is "No Operation".
4. Addresses do not have to be accessed sequentially since $ADS = V_{IL}$ constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
5. "NOP" is "No Operation." Data in memory at the selected address may be corrupted and should be re-written to guarantee data integrity.

Timing Waveform of Flow-Through Read-to-Write-to-Read ($\overline{OE} = V_{IL}$)⁽³⁾



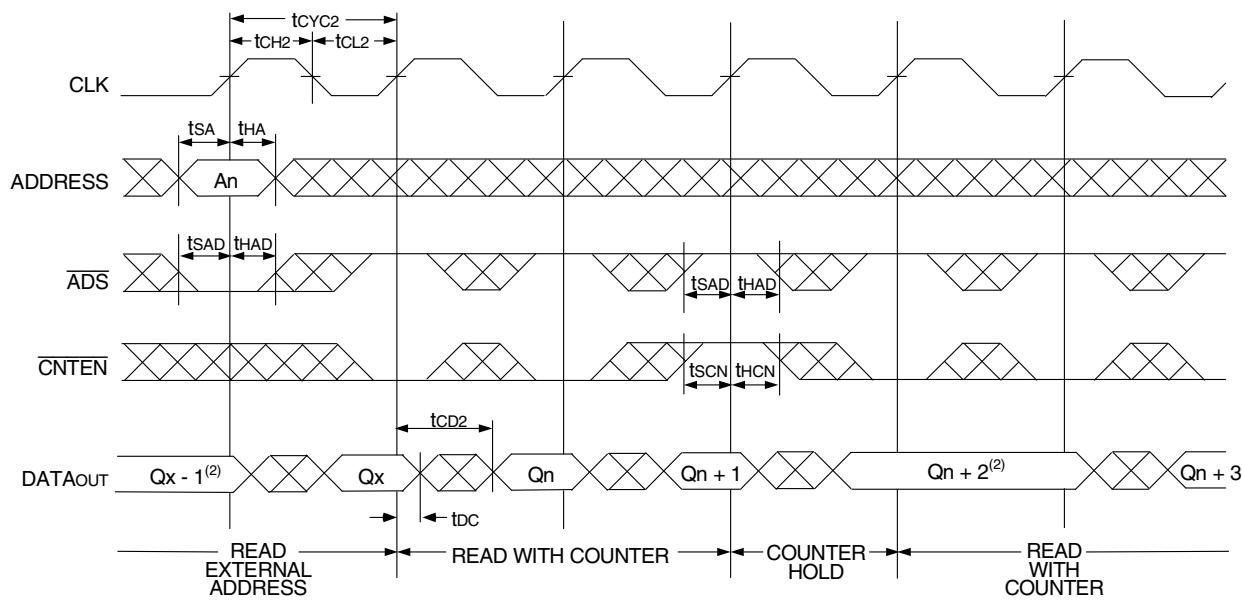
Timing Waveform of Flow-Through Read-to-Write-to-Read (OE Controlled)⁽³⁾



NOTES:

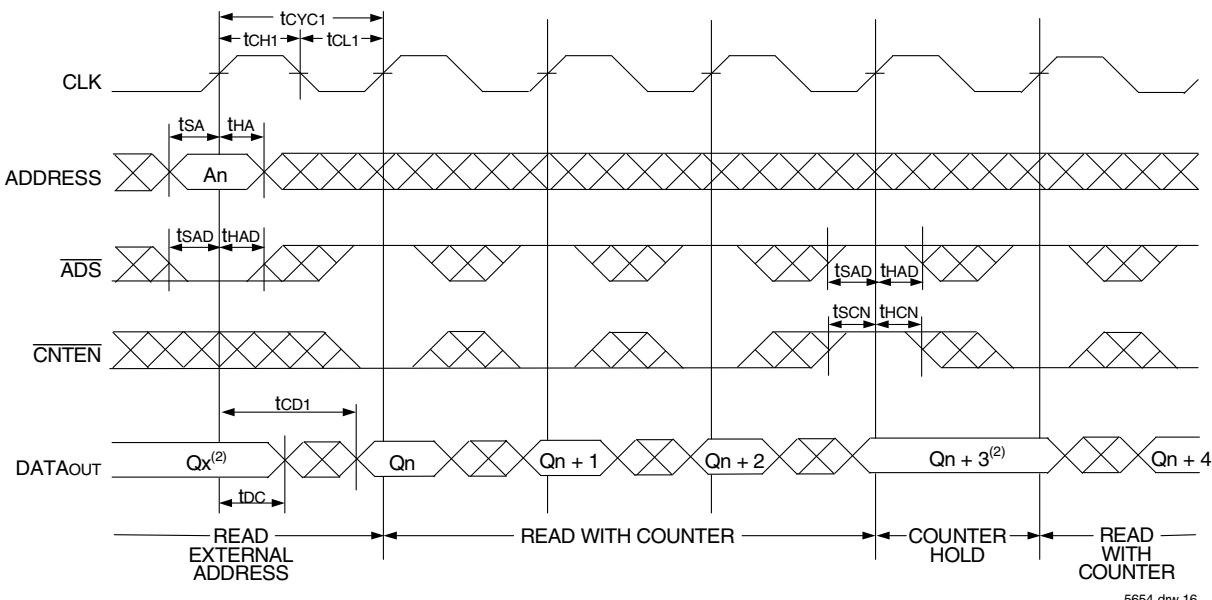
1. Transition is measured 0mV from Low or High-impedance voltage with the Output Test Load (Figure 2).
2. Output state (High, Low, or High-impedance) is determined by the previous cycle control signals.
3. \overline{CE}_0 and $\overline{ADS} = V_{IL}$; CE_1 , \overline{CNTEN} , and $\overline{CNTRST} = V_{IH}$. "NOP" is "No Operation".
4. Addresses do not have to be accessed sequentially since $ADS = V_{IL}$ constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
5. "NOP" is "No Operation." Data in memory at the selected address may be corrupted and should be re-written to guarantee data integrity.

Timing Waveform of Pipelined Read with Address Counter Advance⁽¹⁾



5654 drw 15

Timing Waveform of Flow-Through Read with Address Counter Advance⁽¹⁾

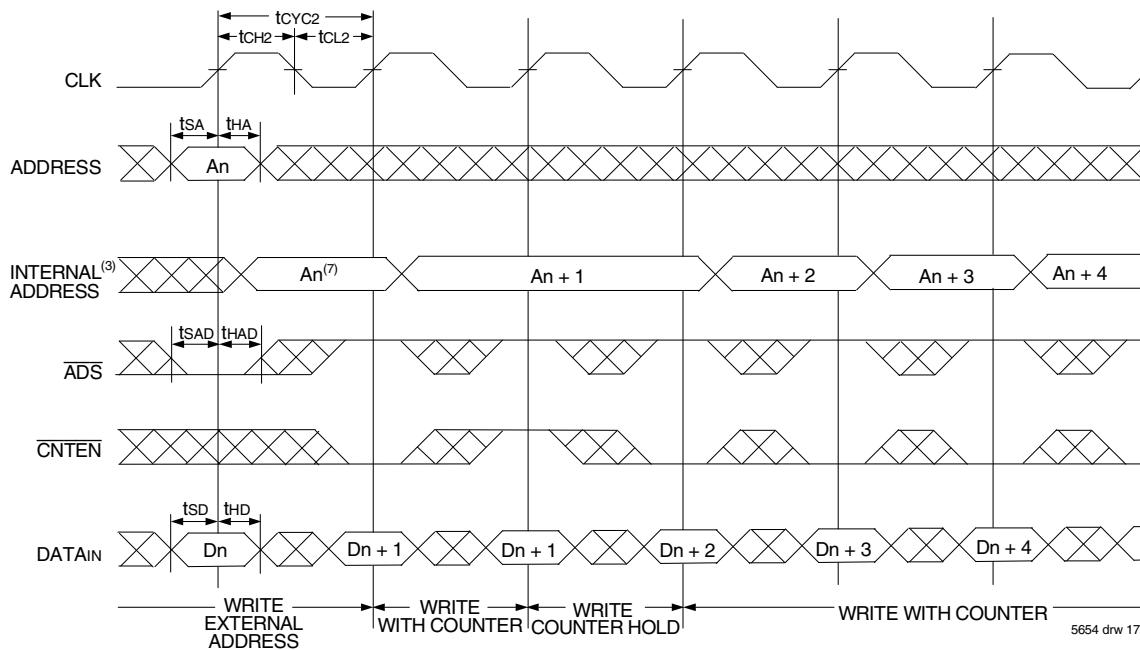


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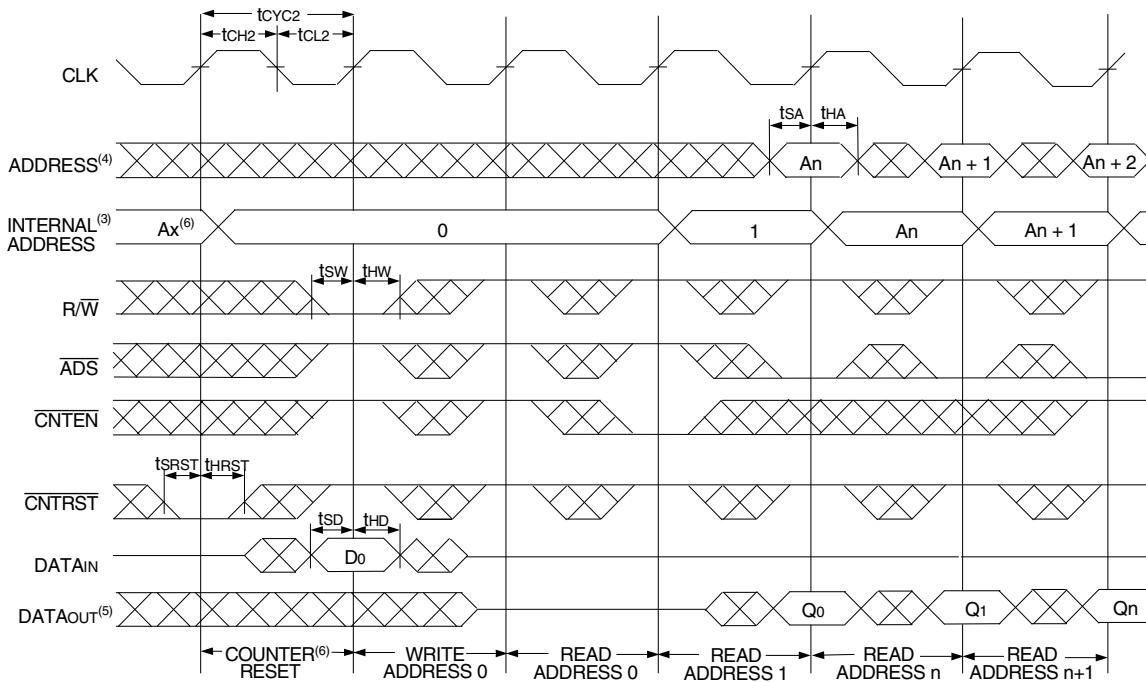
NOTES:

1. \overline{CE}_0 and \overline{OE} = V_{IL} , CE_1 , R/W , and $\overline{CNTRST} = V_{IH}$.
2. If there is no address change via $\overline{ADS} = V_{IL}$ (loading a new address) or $\overline{CNTEN} = V_{IL}$ (advancing the address), i.e. $\overline{ADS} = V_{IH}$ and $\overline{CNTEN} = V_{IH}$, then the data output remains constant for subsequent clocks.

Timing Waveform of Write with Address Counter Advance (Flow-Through or Pipelined Outputs)⁽¹⁾



Timing Waveform of Counter Reset (Pipelined Outputs)⁽²⁾



NOTES:

1. CE₀ and R/W = V_{IL}; CE₁ and CNTRST = V_{IH}.
2. CE₀ = V_{IL}; CE₁ = V_{IH}.
3. The "Internal Address" is equal to the "External Address" when ADS = V_{IL} and equals the counter output when ADS = V_{IH}.
4. Addresses do not have to be accessed sequentially since ADS = V_{IL} constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
5. Output state (High, Low, or High-impedance) is determined by the previous cycle control signals.
6. No dead cycle exists during counter reset. A READ or WRITE cycle may be coincidental with the counter reset cycle.
7. CNTRST = V_{IL} advances Internal Address from 'An' to 'An + 1'. The transition shown indicates the time required for the counter to advance. The 'An + 1' Address is written to during this cycle.

A Functional Description

The IDT70T9169/59 provides a true synchronous Dual-Port Static RAM interface. Registered inputs provide minimal set-up and hold times on address, data, and all critical control inputs. All internal registers are clocked on the rising edge of the clock signal, however, the self-timed internal write pulse is independent of the LOW to HIGH transition of the clock signal.

An asynchronous output enable is provided to ease asynchronous bus interfacing. Counter enable inputs are also provided to stall the operation of the address counters for fast interleaved memory applications.

$\overline{CE}_0 = V_{IH}$ or $CE_1 = V_{IL}$ for one clock cycle will power down the internal circuitry to reduce static power consumption. Multiple chip enables allow easier banking of multiple IDT70T9169/59's for depth expansion configurations. When the Pipelined output mode is enabled, two cycles are required to get valid data on the outputs.

Depth and Width Expansion

The IDT70T9169/59 features dual chip enables (refer to Truth Table I) in order to facilitate rapid and simple depth expansion with no requirements for external logic. Figure 4 illustrates how to control the various chip enables in order to expand two devices in depth.

The IDT70T9169/59 can also be used in applications requiring expanded width, as indicated in Figure 4. Since the banks are allocated at the discretion of the user, the external controller can be set up to drive the input signals for the various devices as required to allow for 18-bit or wider applications.

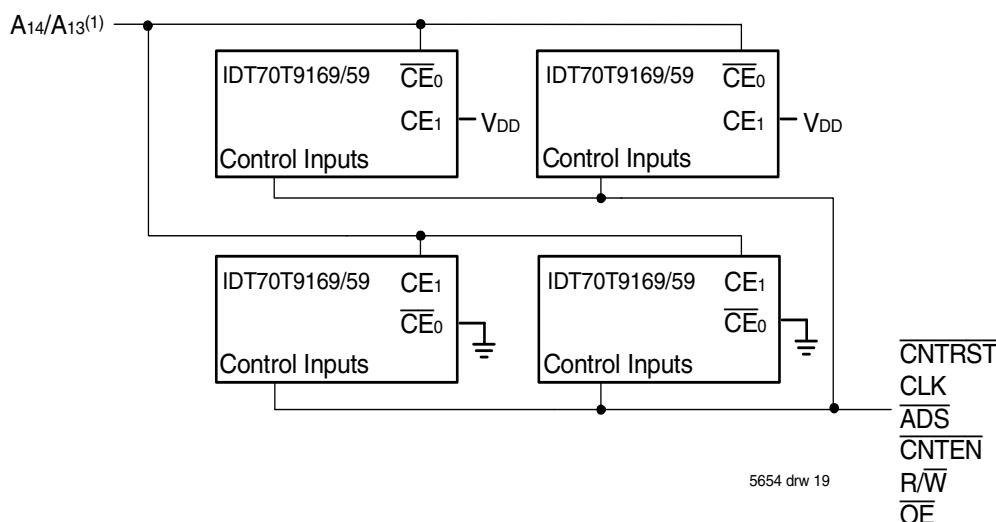
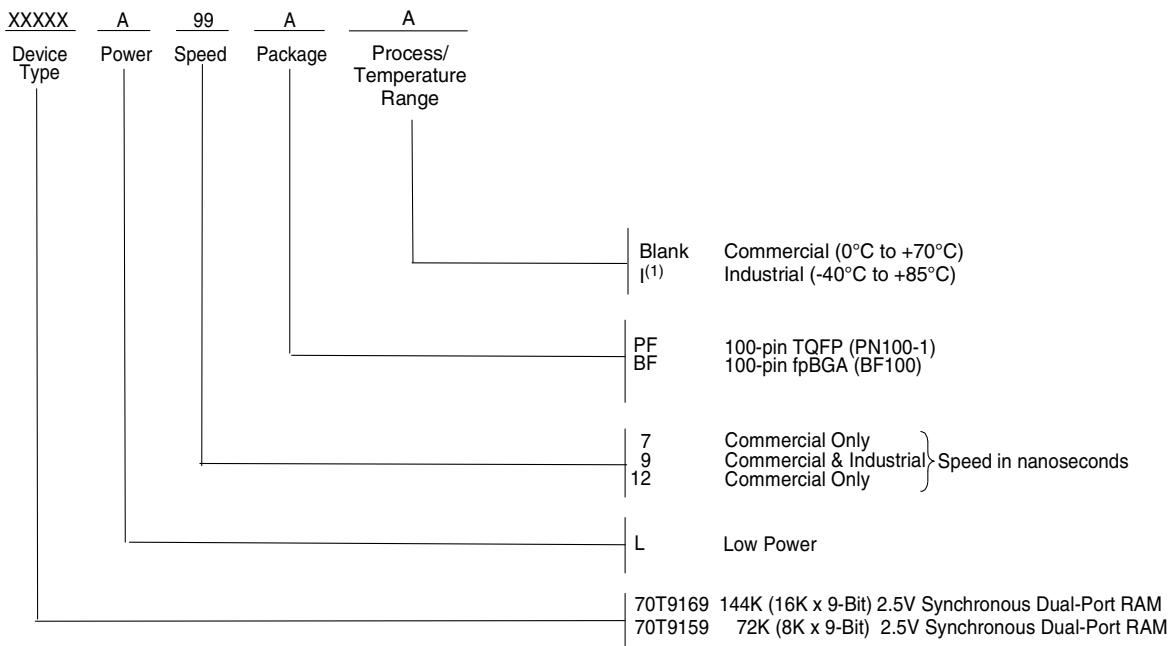


Figure 4. Depth and Width Expansion with IDT70T9169/59

NOTE:

1. A₁₄ is for IDT70T9169, A₁₃ is for IDT70T9159.

Ordering Information



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NOTE:

1. Contact your local sales office for Industrial temp range in other speeds, packages and powers.

Datasheet Document History

07/08/02:	Initial Public Release
08/25/04:	Removed "Preliminary" status
	Page 5 Updated Absolute Maximum Ratings
	Updated Capacitance table
01/29/09:	Page 16 Removed "IDT" from orderable part number
04/26/09:	PDN-F-09-01 issued. See IDT.com for PDN specifics
02/24/14:	70T9169_59 Datasheet changed to Obsolete Status